

Advanced Power MOSFET

IRLZ24A

FEATURES

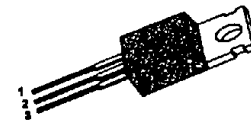
- Logic-Level Gate Drive
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 10 μ A (Max.) @ $V_{DS} = 60V$
- Lower $R_{DS(ON)}$: 0.061 Ω (Typ.)

$$BV_{DSS} = 60 V$$

$$R_{DS(on)} = 0.075 \Omega$$

$$I_D = 17 A$$

TO-220



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current ($T_C=25^\circ\text{C}$)	17	A
	Continuous Drain Current ($T_C=100^\circ\text{C}$)	12	
I_{DM}	Drain Current-Pulsed	60	A
V_{GS}	Gate-to-Source Voltage	± 0	V
E_{AS}	Single Pulsed Avalanche Energy	149	mJ
I_{AR}	Avalanche Current	17	A
E_{AR}	Repetitive Avalanche Energy	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt	5.5	V/ns
P_D	Total Power Dissipation ($T_C=25^\circ\text{C}$)	45	W
	Linear Derating Factor	0.3	
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	$^\circ\text{C}$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	3.3	$^\circ\text{C/W}$
$R_{\theta CS}$	Case-to-Sink	0.5	--	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

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Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	60	--	--	V	$V_{GS}=0V, I_D=250\mu A$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.056	--	V/°C	$I_D=250\mu A$ See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	1.0	--	2.0	V	$V_{DS}=5V, I_D=250\mu A$
I_{GSS}	Gate-Source Leakage, Forward	--	--	100	nA	$V_{GS}=20V$
	Gate-Source Leakage, Reverse	--	--	-100		$V_{GS}=-20V$
I_{DSS}	Drain-to-Source Leakage Current	--	--	10	μA	$V_{DS}=60V$
		--	--	100		$V_{DS}=48V, T_C=150^\circ C$
$R_{DS(on)}$	Static Drain-Source On-State Resistance	--	--	0.075	Ω	$V_{GS}=5V, I_D=8.5A$ ④
g_{fs}	Forward Transconductance	--	9.7	--	\bar{v}	$V_{DS}=30V, I_D=8.5A$ ④
C_{iss}	Input Capacitance	--	560	730	pF	$V_{GS}=0V, V_{DS}=25V, f=1MHz$ See Fig 5
C_{oss}	Output Capacitance	--	195	225		
C_{rss}	Reverse Transfer Capacitance	--	77	90		
$t_{d(on)}$	Turn-On Delay Time	--	12	35	ns	$V_{DD}=30V, I_D=17A,$ $R_G=9\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	--	21	55		
$t_{d(off)}$	Turn-Off Delay Time	--	32	75		
t_f	Fall Time	--	21	55		
Q_g	Total Gate Charge	--	15	20	nC	$V_{DS}=48V, V_{GS}=5V,$ $I_D=17A$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	--	4.4	--		
Q_{gd}	Gate-Drain("Miller") Charge	--	7.3	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	17	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	60		
V_{SD}	Diode Forward Voltage ④	--	--	1.5	V	$T_J=25^\circ C, I_S=17A, V_{GS}=0V$
t_{rr}	Reverse Recovery Time	--	55	--	ns	$T_J=25^\circ C, I_F=17A$
Q_{rr}	Reverse Recovery Charge	--	0.091	--	μC	$di_F/dt=100A/\mu s$ ④

Notes ;

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=0.6mH, I_{AS}=17A, V_{DO}=25V, R_G=27\Omega$, Starting $T_J=25^\circ C$
- ③ $I_{SD} \leq 17A, di/dt \leq 250A/\mu s, V_{DO} \leq BV_{DSS}$, Starting $T_J=25^\circ C$
- ④ Pulse Test : Pulse Width = 250 μs , Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

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Fig 1. Output Characteristics

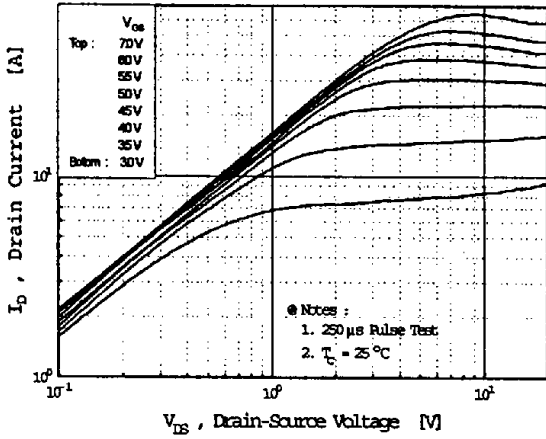


Fig 2. Transfer Characteristics

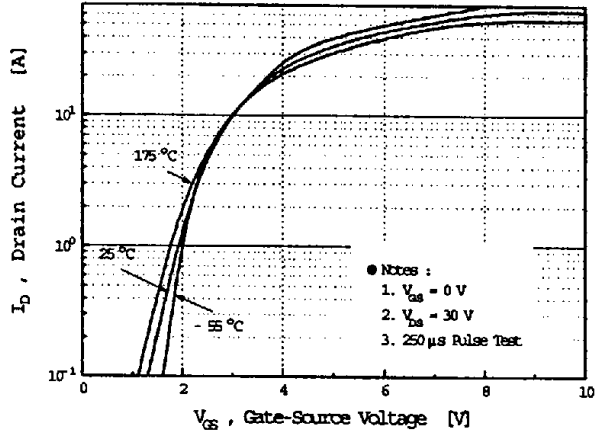


Fig 3. On-Resistance vs. Drain Current

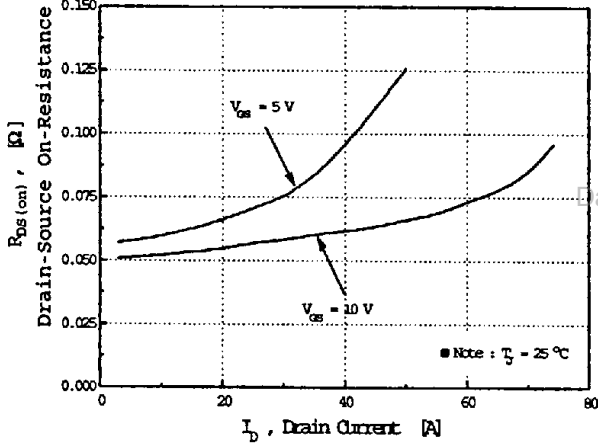


Fig 4. Source-Drain Diode Forward Voltage

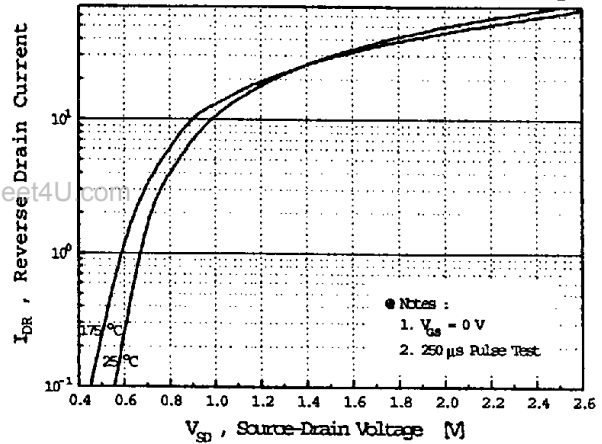


Fig 5. Capacitance vs. Drain-Source Voltage

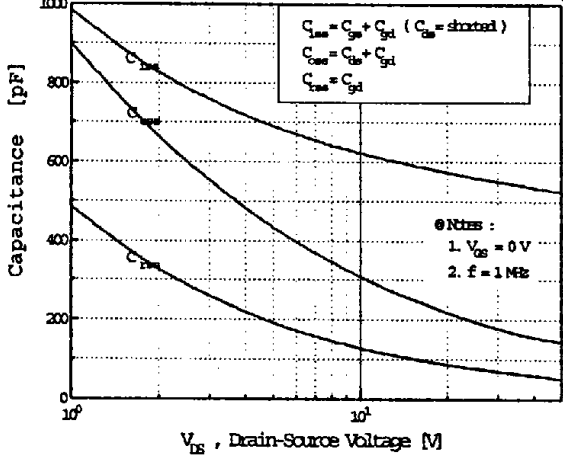
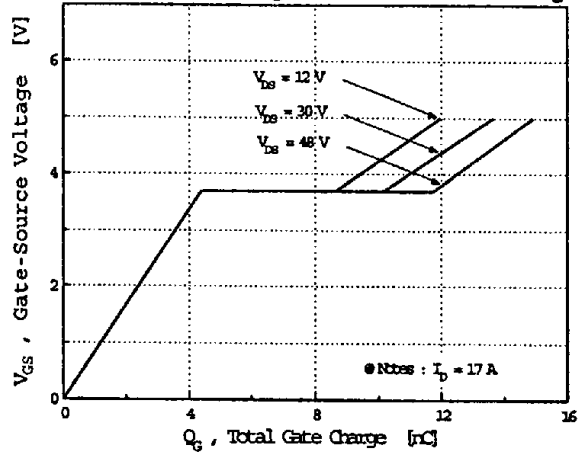


Fig 6. Gate Charge vs. Gate-Source Voltage



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Fig 7. Breakdown Voltage vs. Temperature

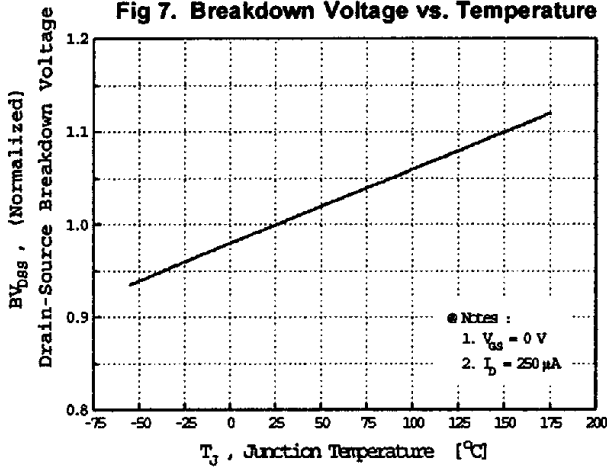


Fig 8. On-Resistance vs. Temperature

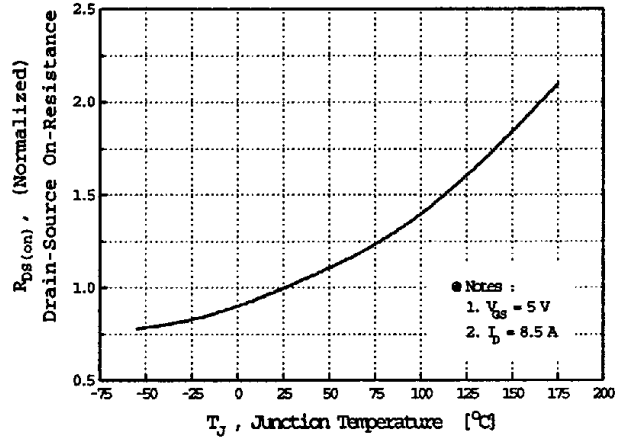


Fig 9. Max. Safe Operating Area

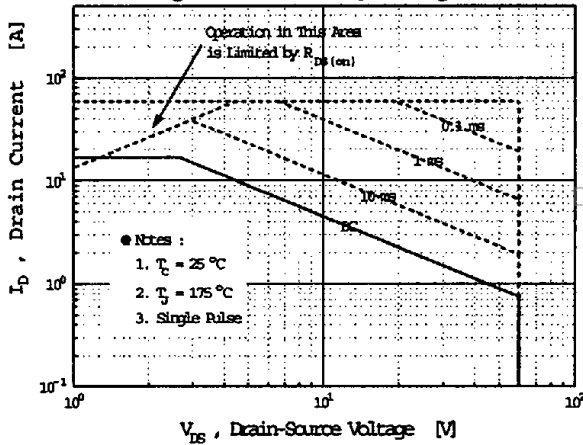


Fig 10. Max. Drain Current vs. Case Temperature

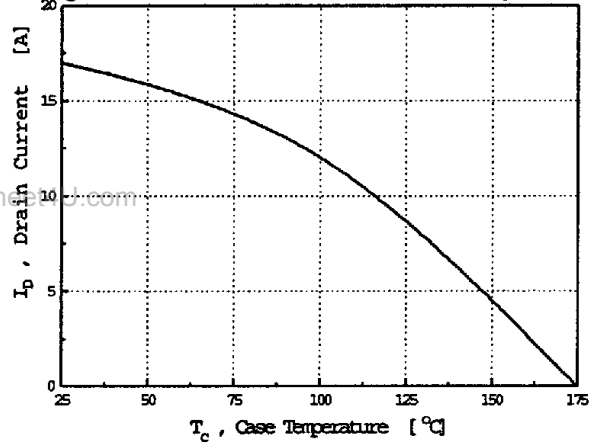
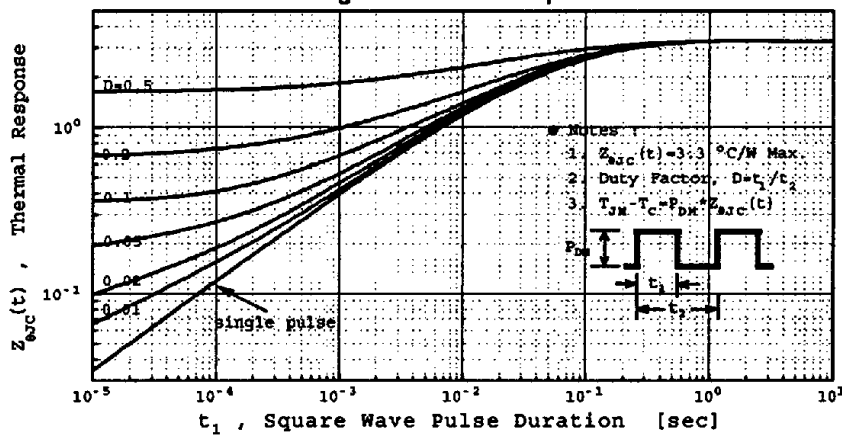


Fig 11. Thermal Response



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Fig 12. Gate Charge Test Circuit & Waveform

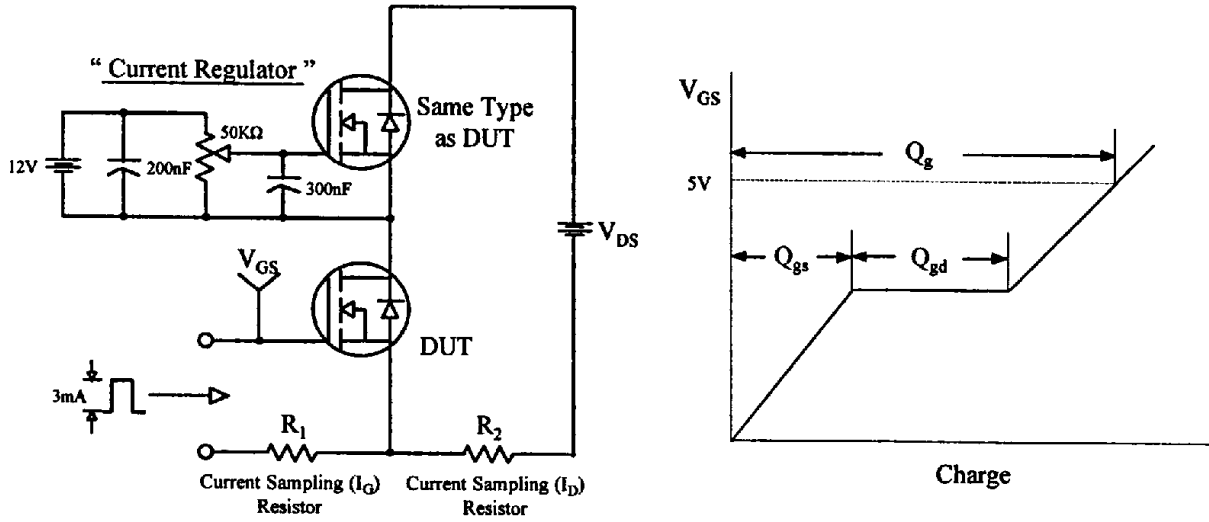


Fig 13. Resistive Switching Test Circuit & Waveforms

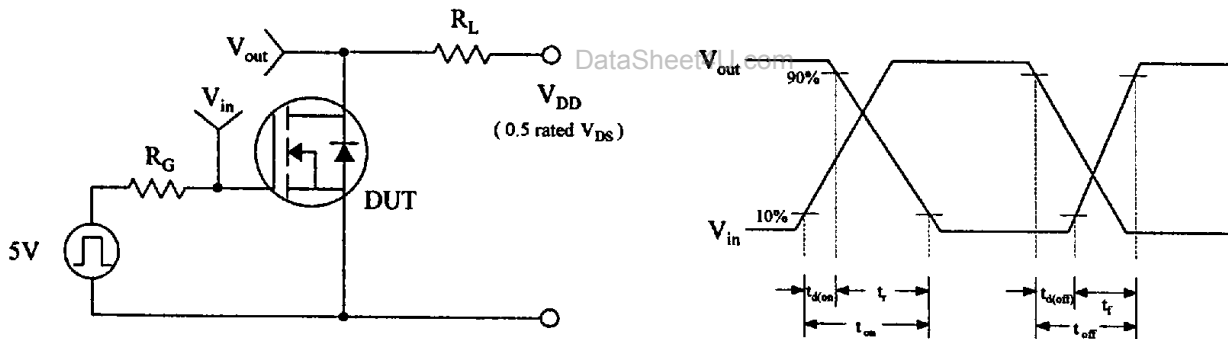
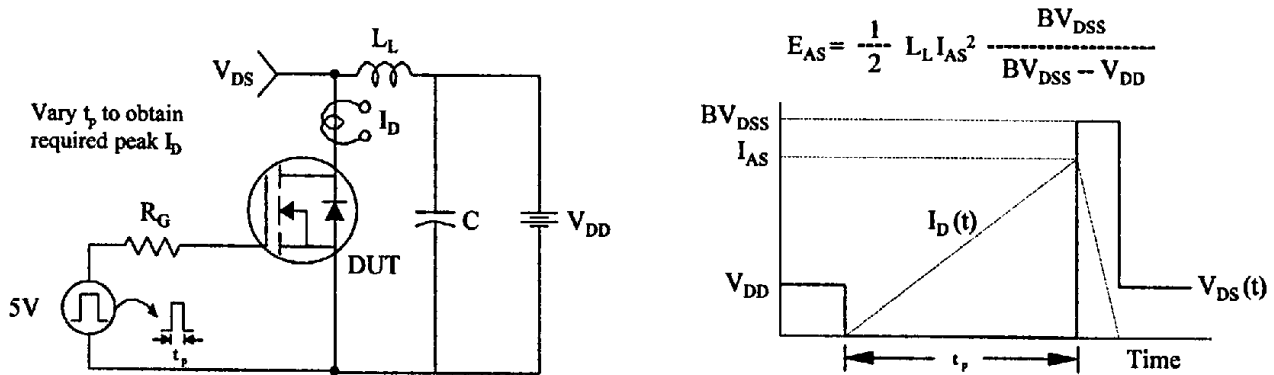


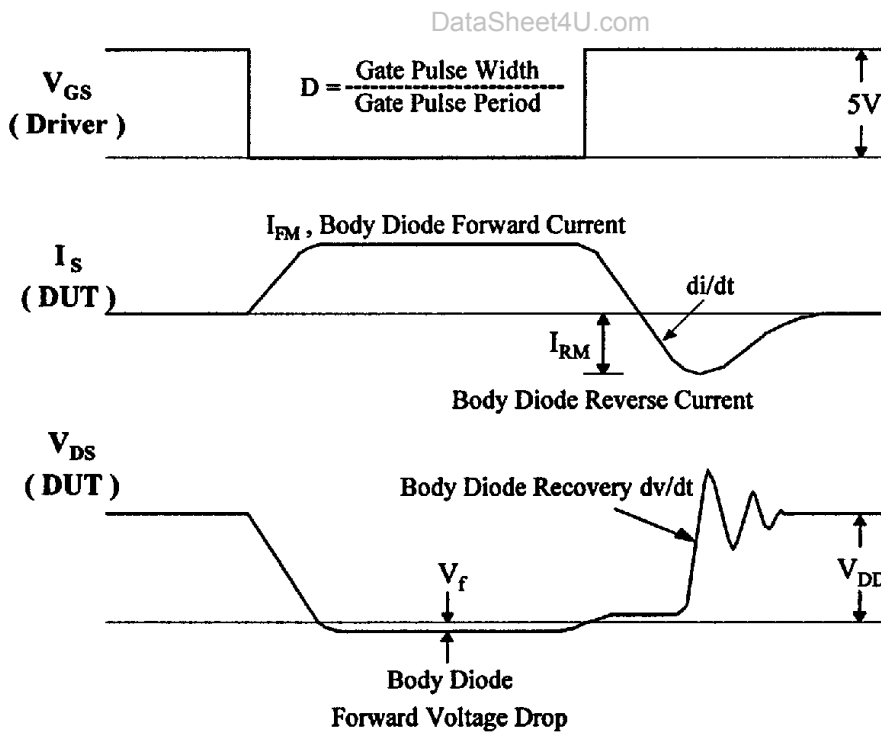
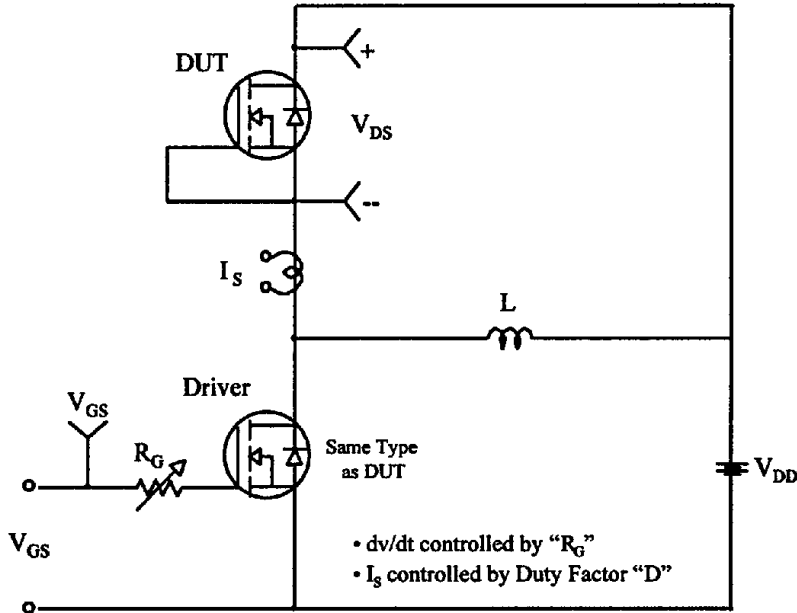
Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



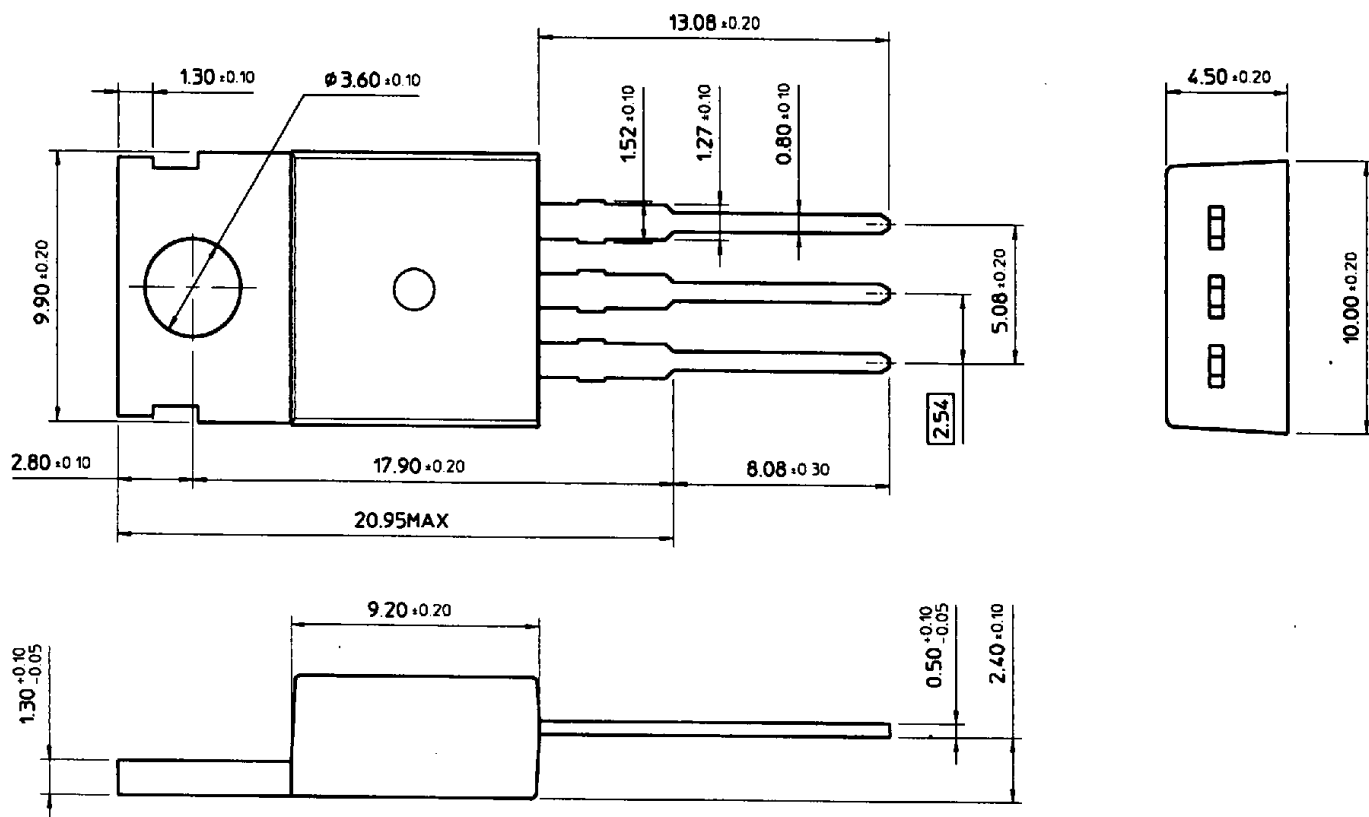
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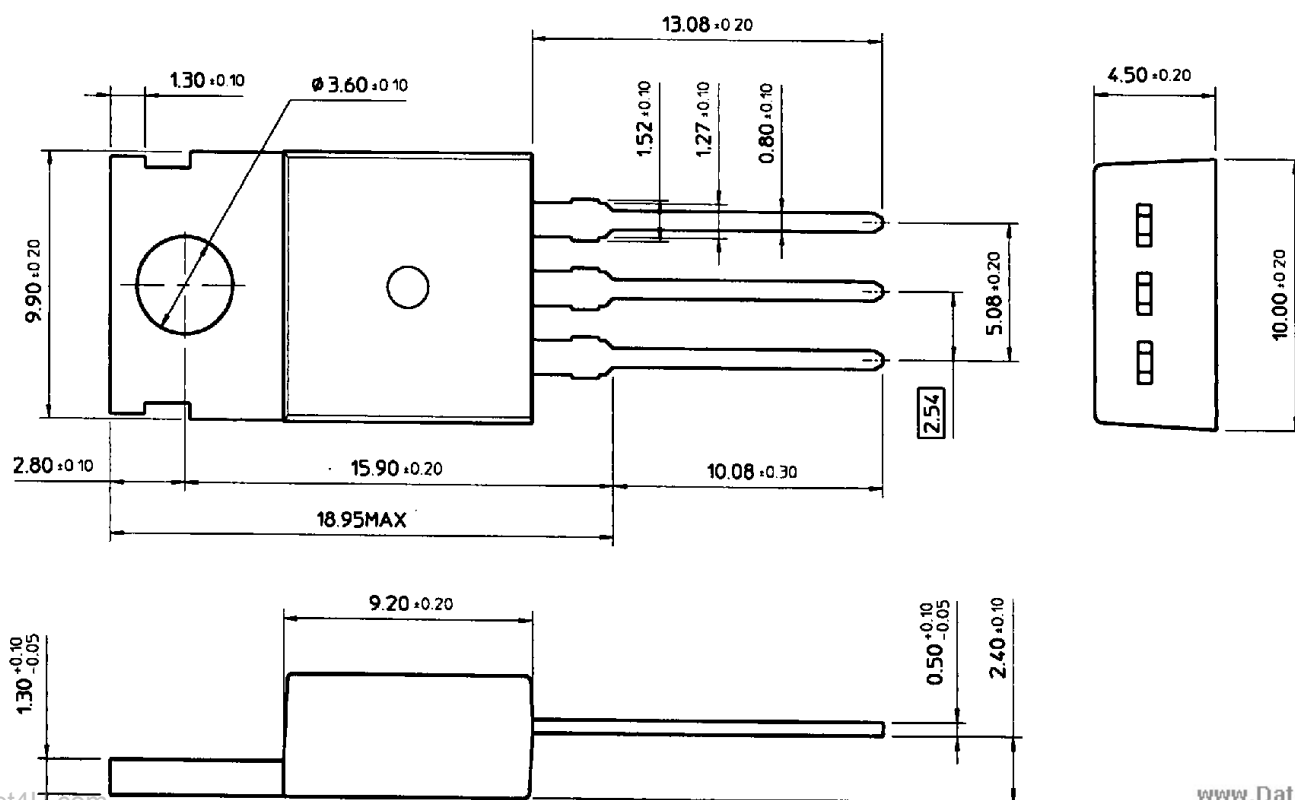
Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



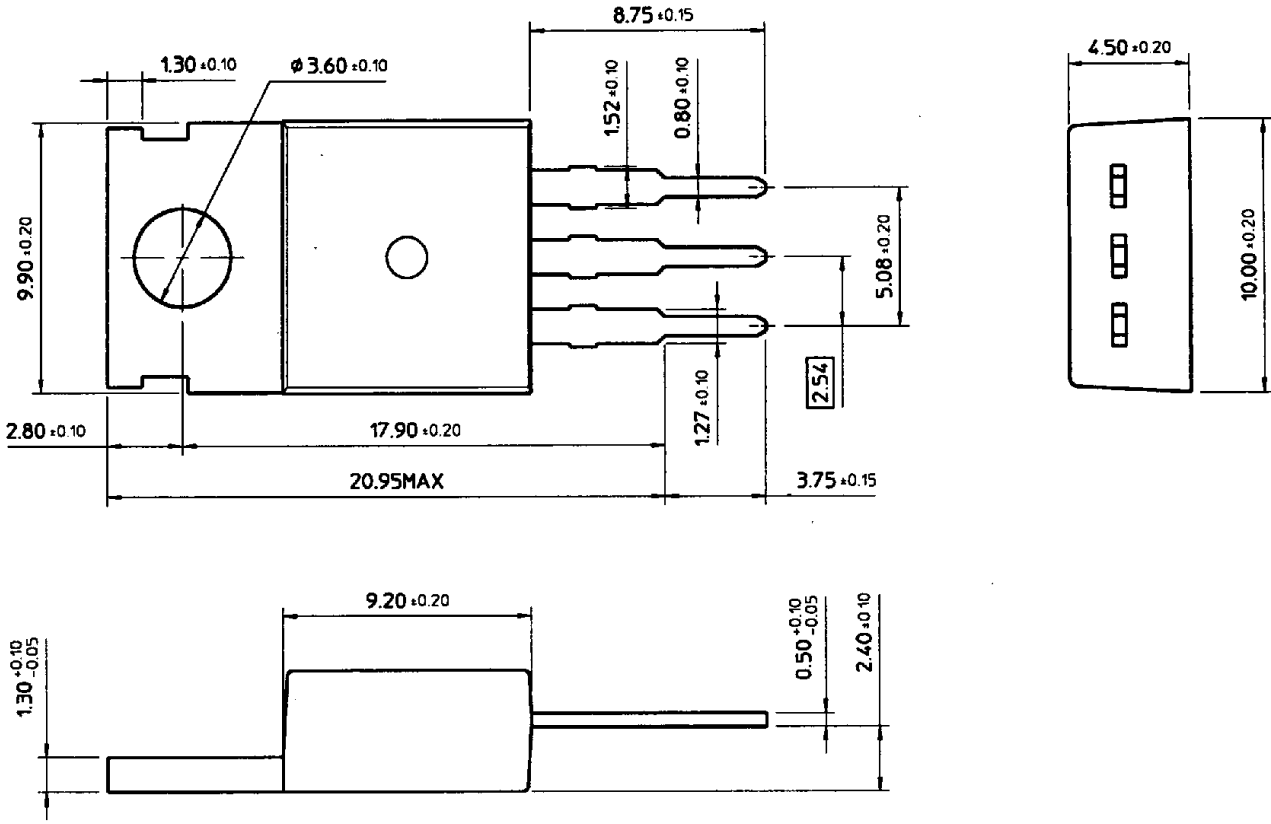
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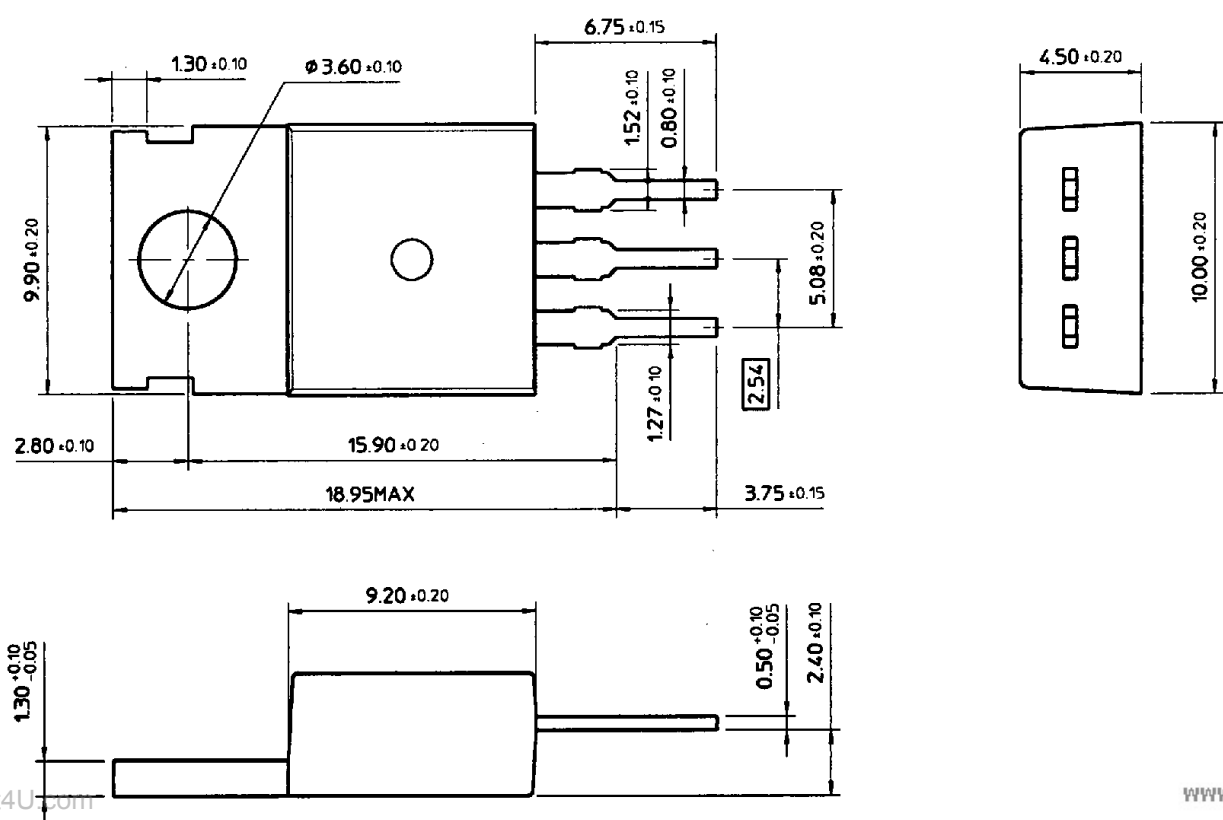
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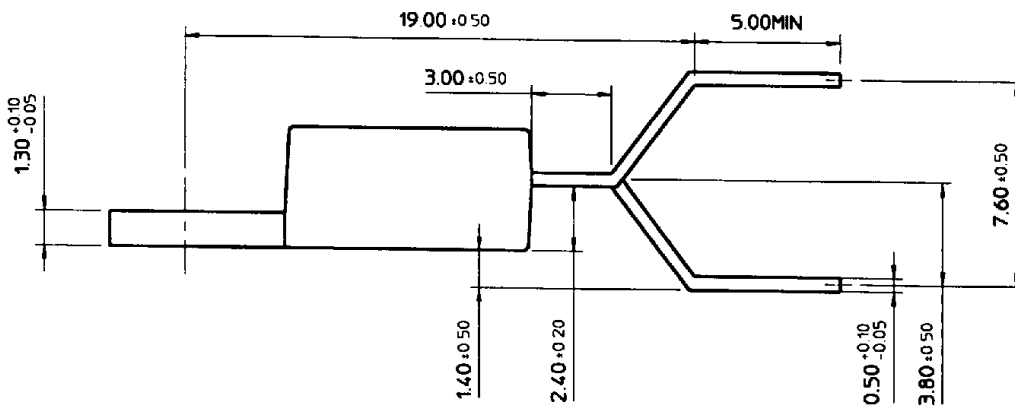
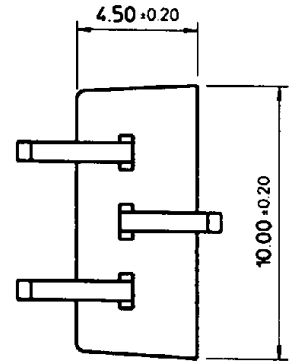
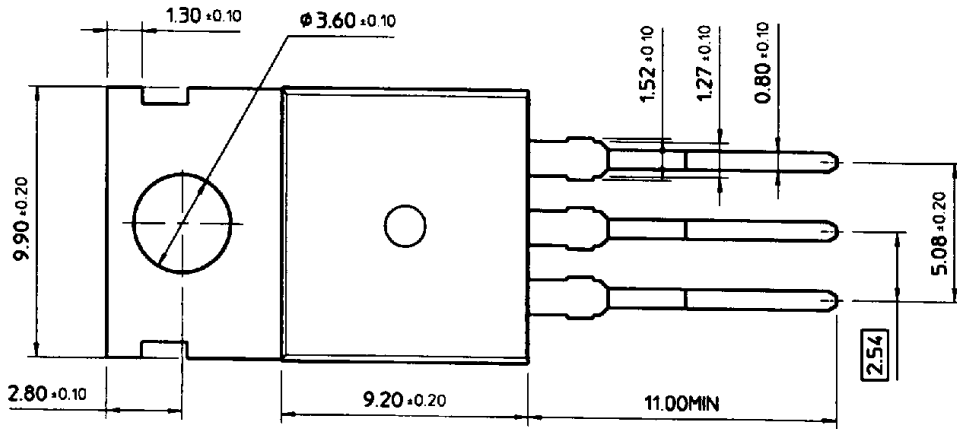
TO-220 (3)



TO-220 (4)



0-220 (5)



NOTE